# **MOSFET** - Power, Single, P-Channel, SC-70

# -20 V, -1.37 A

#### Features

- Leading -20 V Trench for Low R<sub>DS(on)</sub>
- -2.5 V Rated for Low Voltage Gate Drive
- SC-70 Surface Mount for Small Footprint (2x2 mm)
- Pb-Free Package is Available

#### Applications

- High Side Load Switch
- Charging Circuit
- Single Cell Battery Applications such as: Cell Phones, Digital Cameras, PDAs

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

Parameter			Symbol	Value	Units
Drain-to-Source Voltage			V <sub>DSS</sub>	-20	V
Gate-to-Source Voltage			V <sub>GS</sub>	±8	V
Continuous Drain	Steady	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	-1.37	А
Current (Note 1)	State	$T_A = 70^{\circ}C$		-0.62	
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	PD	0.329	W
Pulsed Drain Current	t <sub>p</sub> =	10 μs	I <sub>DM</sub>	-4.0	А
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>STG</sub>	–55 to 150	°C
Source Current (Body Diode), Continuous			۱ <sub>S</sub>	-0.5	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Units
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	380	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in sq pad size

(Cu area = 1.127 in sq [1 oz] including traces).

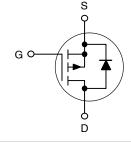


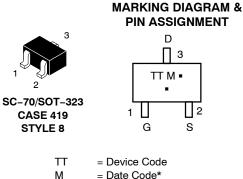
# **ON Semiconductor®**

#### http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> Typ	I <sub>D</sub> Max
	83 mΩ @ –4.5 V	
–20 V	88 mΩ @ –3.6 V	–1.37 A
	104 mΩ @ −2.5 V	







= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTS4101PT1	SOT-323	3000/Tape & Reel
NTS4101PT1G	SOT-323 (Pb-Free)	3000/Tape & Reel

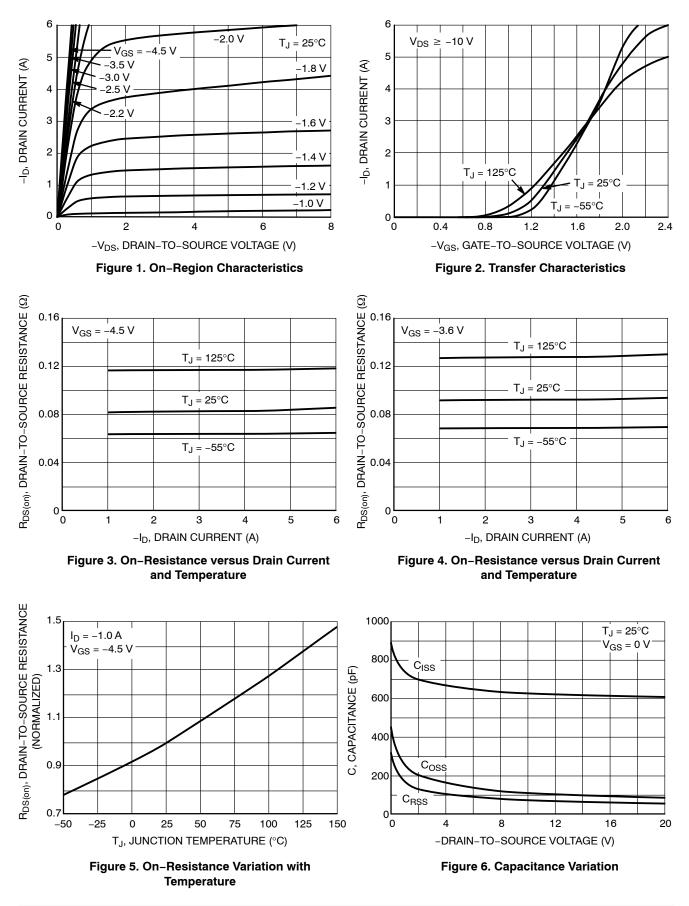
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### ELECTRICAL CHARACTERISTICS (TJ=25°C unless otherwise stated)

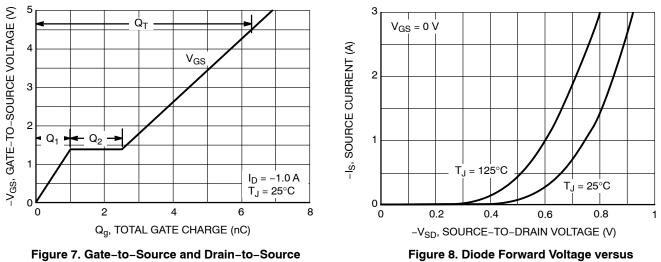
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> =	= –250 μA	-20	-24.5		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				-13.7		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$			-1.0	μΑ
		V <sub>DS</sub> = -16 V	$T_J = 70^{\circ}C$			-5.0	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>C</sub>	<sub>iS</sub> = ±8 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D$	= –250 μA	-0.45	-0.64	-1.5	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				2.7		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -1.0 A			83	120	mΩ
		V <sub>GS</sub> = -3.6 V, I	<sub>D</sub> = -0.7 A		88	130	
	V <sub>GS</sub> = -2.5 V, I <sub>D</sub>		<sub>D</sub> = -0.3 A		104	160	1
Forward Transconductance	G <sub>FS</sub>	$V_{DS} = -5.0 \text{ V}, \text{ I}_{D} = -1.3 \text{ A}$			5.2		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = -20 V			603	840	pF
Output Capacitance	C <sub>OSS</sub>				90	125	
Reverse Transfer Capacitance	C <sub>RSS</sub>				62	85	
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = -4.5 V, $V_{DS}$ = -4.5 V,			6.4	9.0	nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	I <sub>D</sub> = -1.0	DA -		0.7		1
Gate-to-Source Charge	Q <sub>GS</sub>				1.0		1
Gate-to-Drain Charge	Q <sub>GD</sub>				1.5		-
SWITCHING CHARACTERISTICS (No	ote 3)				•		
Turn–On Delay Time	t <sub>d(ON)</sub>	$V_{GS} = -4.5 V, V_{E}$	D = -4.0 V,		6.2	12	ns
Rise Time	t <sub>r</sub>	I <sub>D</sub> = –1.0 A, R	<sub>G</sub> = 6.2 Ω		14.9	25	
Turn-Off Delay Time	t <sub>d(OFF)</sub>				26	40	
Fall Time	t <sub>f</sub>				18	30	
DRAIN-SOURCE DIODE CHARACTE	RISTICS				•		
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$		-0.61	-1.2	V
		I <sub>S</sub> = -0.3 A	T <sub>J</sub> = 125°C		-0.5		
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS}$ = 0 V, dI_{SD}/dt = 100 A/µs, $I_{S}$ = –1.0 A			10.9	20	ns
Charge Time	Ta				7.1		
Discharge Time	Tb				3.8		
Reverse Recovery Charge	Q <sub>RR</sub>				4.25		nC

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



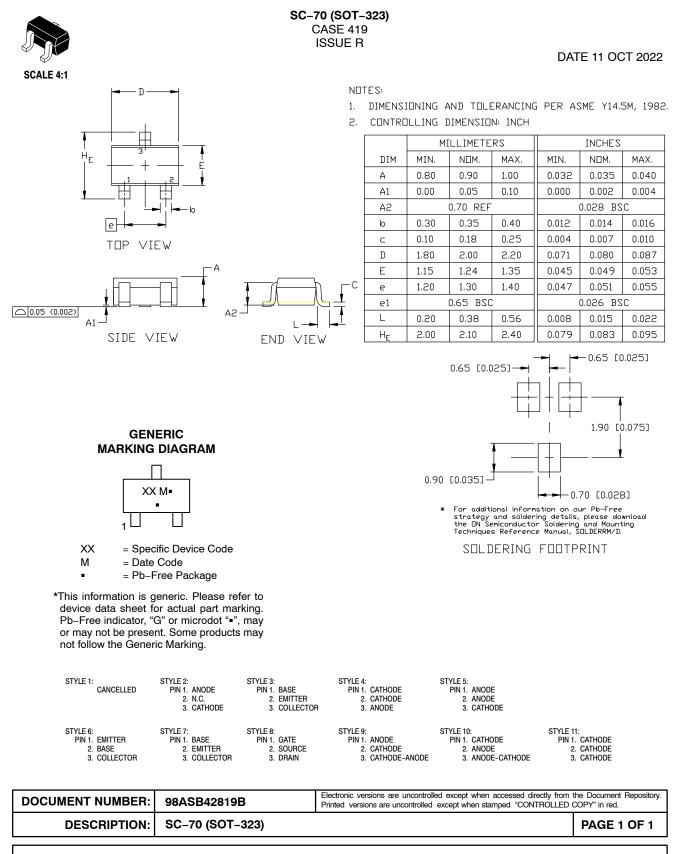
## **TYPICAL CHARACTERISTICS**



Current

Voltage versus Total Charge

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